

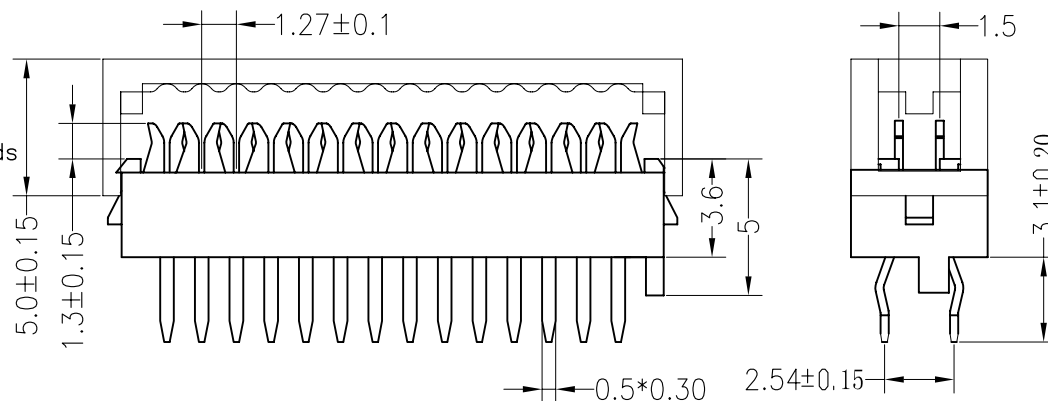
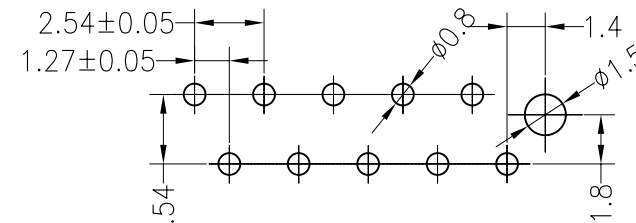
HSF RoHS

SPECIFICATIONS

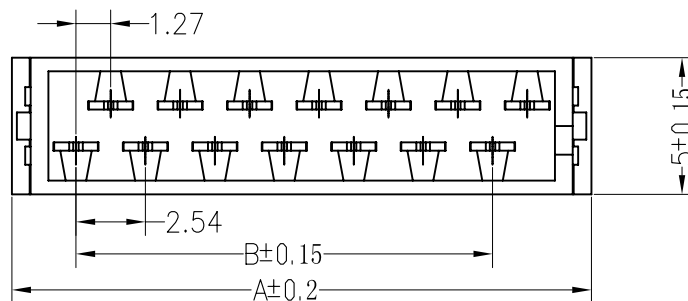
Rated Current:1.0AMP
 Contact Resistance:20mΩ Max
 Withstand Voltage:500V AC/DC
 Insulation Resistance:1000MΩ Min
 Operation Temperature:-40°C to +105°C

Contact Material:Brass
 Contact Plating:Sn Over Ni
 Insulator Material:Polyester(UL94V-0)
 Standard: PBT
 Max.Processing Temp: 180°C for 30-60 seconds
 (200°C for 5 seconds)

Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)



PINS	A	B
4	8.45	2.54
6	10.99	5.08
8	13.53	7.62
10	16.07	10.16
12	18.61	12.70
14	21.15	15.24
16	23.69	17.78
18	26.23	20.32
20	28.77	22.86
22	31.31	25.40
24	33.85	27.94
26	36.39	30.48




Ordering Information

4000- XX M I SN X N T 03

No.of Pins
04~26P

Insulator Material
A=PBT
E=PA46

Packing
T=Tube

REV		DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION		DRAW	YiYuSheng	12.04.11	SCALE	FIT	
A0		2012.04.11	NEW DRAWING		X.X	±0.30				UNIT	mm	
					X.XX	±0.20	SIZE	A4				
					X.XXX	±0.10	SHEET	1/1				
					Angle	±3°	PROJ.	☉ ↗				
					DIM	TOL	APPROVE		PART NO.		4000-XXMISNXNT03	
									TITLE:		MICRO MATCH DIP Male IDC-Type	